February 1994 Revised May 2005

FAIRCHILD

SEMICONDUCTOR®

74LCX16374 Low Voltage 16-Bit D-Type Flip-Flop with 5V Tolerant Inputs and Outputs

General Description

The LCX16374 contains sixteen non-inverting D-type flip-flops with 3-STATE outputs and is intended for bus oriented applications. The device is byte controlled. A buffered clock (CP) and Output Enable (\overline{OE}) are common to each byte and can be shorted together for full 16-bit operation.

The LCX16374 is designed for low voltage (2.5V or 3.3V) $\rm V_{CC}$ applications with capability of interfacing to a 5V signal environment.

The LCX16374 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

Features

- 5V tolerant inputs and outputs
- 2.3V–3.6V V_{CC} specifications provided
- 6.2 ns t_{PD} max (V_{CC} = 3.3V), 20 μ A I_{CC} max
- Power down high impedance inputs and outputs
- Supports live insertion/withdrawal (Note 1)
- \pm 24 mA output drive (V_{CC} = 3.0V)
- Uses proprietary noise/EMI reduction circuitry
- Latch-up performance exceeds 500 mA
- ESD performance: Human body model > 2000V
 - Machine model > 200V
- Also packaged in plastic Fine-Pitch Ball Grid Array (FBGA)

Note 1: To ensure the high-impedance state during power up or down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pull-up resistor: the minimum value or the resistor is determined by the current-sourcing capability of the driver.

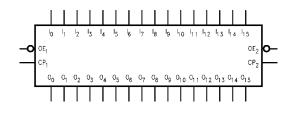
Ordering Code:

Order Number	Package Number	Package Description
74LCX16374G (Note 2)(Note 3)	BGA54A	54-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide
74LCX16374MEA (Note 3)	MS48A	48-Lead Small Shrink Outline Package (SSOP), JEDEC MO-118, 0.300" Wide
74LCX16374MTD (Note 3)	MTD48	48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Note 2: Ordering code "G" indicates Trays.

Note 3: Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbol



74LCX16374

Pin Assignment for SSOP and TSSOP ŌĒ, CP1 0₀ -47 - 1₀ 0, 46 - 1. GND 4.5 - GND 0₂ · 44 - 1, 03 43 ۰I₃ 4.2 - v_{cc} Vcc 04 41 - 14 0s 40 - I., 39 GND 10 - GND 06 11 38 - I₆ 12 37 07 - 1-36 08 13 - I₈ 35 0₉ 14 - I₉ GND 15 34 - GND 0₁₀ -33 16 — I₁₀ 011 17 32 - I_{1 1} 18 31 -v_{cc} V_{CC} 012 19 30 - 1_{1 2} 20 29 013 - 1_{1 3} GND -21 28 — GND 014 22 27 - I₁₄ 23 26 015 - I₁₅ 25 0E2 24 - CP2 Pin Assignment for FBGA 1 2 3 4 5 6 000000 < ш 000000 000000 υ 000000 000000 ш ш 000000 000000 000000 000000 G т _ (Top Thru View)

Connection Diagrams

Pin Descriptions

Pin Names	Description
OEn	Output Enable Input (Active LOW)
CPn	Clock Pulse Input
I ₀ —I ₁₅	Inputs
O ₀ -O ₁₅	Outputs
0 ₀ –0 ₁₅ NC	No Connect

FBGA Pin Assignments

	1	2	3	4	5	6
Α	O ₀	NC	OE ₁	CP1	NC	I ₀
В	0 ₂	0 ₁	NC	NC	I ₁	l ₂
С	O ₄	O ₃	V _{CC}	V _{CC}	I ₃	I ₄
D	O ₆	O ₅	GND	GND	I ₅	I ₆
E	0 ₈	0 ₇	GND	GND	۱ ₇	I ₈
F	0 ₁₀	O ₉	GND	GND	l ₉	I ₁₀
G	O ₁₂	O ₁₁	V _{CC}	V _{CC}	I ₁₁	I ₁₂
н	0 ₁₄	0 ₁₃	NC	NC	I ₁₃	I ₁₄
J	0 ₁₅	NC	OE ₂	CP ₂	NC	I ₁₅

Truth Tables

	Inputs		Outputs
CP ₁	OE ₁	I ₀ –I ₇	0 ₀ –0 ₇
~	L	Н	н
~	L	L	L
L	L	Х	O ₀
х	Н	х	Z
	Inputs		Outputs
CP2	0E2	I ₈ –I ₁₅	0 ₈ –0 ₁₅
~	L	Н	Н
~	L	L	L
 L	L L	L X	L O ₀ Z

H = HIGH Voltage Level

L = LOW Voltage Level

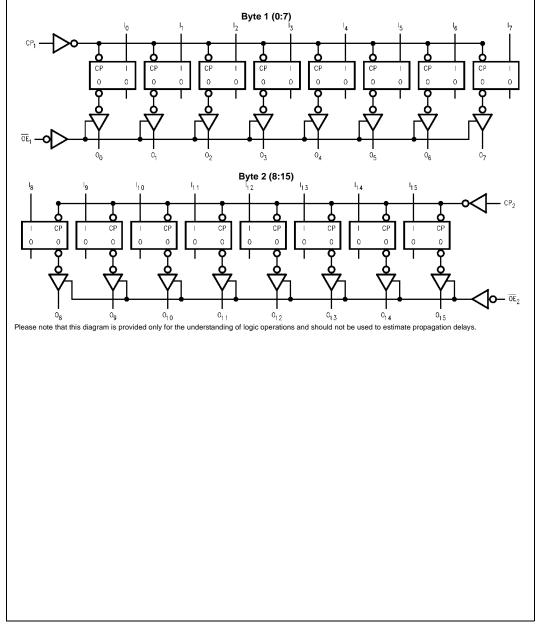
X = Immaterial Z = High Impedance

 $O_0 = Previous O_0$ before HIGH-to-LOW of CP

Functional Description

The LCX16374 consists of sixteen edge-triggered flip-flops with individual D-type inputs and 3-STATE true outputs. The device is byte controlled with each byte functioning identically, but independent of the other. The control pins can be shorted together to obtain full 16-bit operation. Each byte has a buffered clock and buffered Output Enable common to all flip-flops within that byte. The description which follows applies to each byte. Each flip-flop will store the state of their individual D inputs that meet the setup and hold time requirements on the LOW-to-HIGH Clock (CP_n) transition. With the Output Enable (\overline{OE}_n) LOW, the contents of the flip-flops are available at the outputs. When \overline{OE}_n is HIGH, the outputs go to the high impedance state. Operation of the \overline{OE}_n input does not affect the state of the flip-flops.

Logic Diagrams



74LCX16374

Absolute Maximum Ratings(Note 4)

Symbol	Parameter	Value	Conditions	Units	
V _{CC}	Supply Voltage	-0.5 to +7.0		V	
VI	DC Input Voltage	-0.5 to +7.0		V	
Vo	DC Output Voltage	-0.5 to +7.0	3-STATE	V	
		–0.5 to V _{CC} + 0.5	Output in HIGH or LOW State (Note 5)	v	
I _{IK}	DC Input Diode Current	-50	V _I < GND	mA	
I _{OK}	DC Output Diode Current	-50	V _O < GND		
		+50	$V_{O} > V_{CC}$	mA	
I _O	DC Output Source/Sink Current	±50		mA	
I _{CC}	DC Supply Current per Supply Pin	±100		mA	
I _{GND}	DC Ground Current per Ground Pin	±100		mA	
T _{STG}	Storage Temperature	-65 to +150		°C	

Note 4: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 5: I_O Absolute Maximum Rating must be observed.

Recommended Operating Conditions (Note 6)

Symbol	Parameter	Min	Max	Units	
V _{CC}	Supply Voltage	Operating	2.0	3.6	V
		Data Retention	1.5	3.6	v
VI	Input Voltage		0	5.5	V
Vo	Output Voltage	HIGH or LOW State	0	V _{CC}	V
		3-STATE	0	5.5	v
I _{OH} /I _{OL}	Output Current	$V_{CC} = 3.0V - 3.6V$		±24	
		$V_{CC} = 2.7V - 3.0V$		±12	mA
		V _{CC} = 2.3V – 2.7V		±8	
Τ _Α	Free-Air Operating Temperature		-40	85	°C
Δt/ΔV	Input Edge Rate, $V_{IN} = 0.8V - 2.0V$, $V_{CC} = 3.0V$		0	10	ns/V
Note 6: Unu	sed inputs must be held HIGH or LOW. They may not float.			•	-

DC Electrical Characteristics

Symbol	Parameter	Conditions	v _{cc}	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units
Symbol	Farameter	Conditions	(V)	Min	Max	Onita
V _{IH}	HIGH Level Input Voltage		2.3 – 2.7	1.7		v
			2.7 – 3.6	2.0		v
V _{IL}	LOW Level Input Voltage		2.3 – 2.7		0.7	v
			2.7 - 3.6		0.8	v
V _{OH}	HIGH Level Output Voltage	I _{OH} = -100 μA	2.3 – 3.6	V _{CC} - 0.2		
		I _{OH} = -8 mA	2.3	1.8		
		$I_{OH} = -12 \text{ mA}$	2.7	2.2		V
		I _{OH} = -18 mA	3.0	2.4		
		$I_{OH} = -24 \text{ mA}$	3.0	2.2		
V _{OL}	LOW Level Output Voltage	I _{OL} = 100 μA	2.3 - 3.6		0.2	
		$I_{OL} = 8 \text{ mA}$	2.3		0.6	
		$I_{OL} = 12 \text{ mA}$	2.7		0.4	V
		I _{OL} = 16 mA	3.0		0.4	
		$I_{OL} = 24 \text{ mA}$	3.0		0.55	
l _l	Input Leakage Current	$0 \le V_I \le 5.5 V$	2.3 - 3.6		±5.0	μA
I _{OZ}	3-STATE Output Leakage	$0 \le V_O \le 5.5V$	2.3 – 3.6		±5.0	μA
		$V_I = V_{IH} \text{ or } V_{IL}$	2.3 - 3.0		±3.0	μΑ
IOFF	Power-Off Leakage Current	$V_1 \text{ or } V_0 = 5.5 V$	0	1	10	μΑ

DC Electrical Characteristics (Continued)

Paramotor	Conditions	V _{CC}	T _A = -40°0	C to +85°C	Units
Falameter	Conditions	(V)	Min	Max	Units
Quiescent Supply Current	$V_I = V_{CC} \text{ or } GND$	2.3 - 3.6		20	μА
	$3.6V \leq V_{I}, \ V_{O} \leq 5.5V$ (Note 7)	2.3 - 3.6		±20	μΛ
Increase in I _{CC} per Input	$V_{IH} = V_{CC} - 0.6V$	2.3 - 3.6		500	μA
		Quiescent Supply Current $V_1 = V_{CC}$ or GND $3.6V \le V_1, V_0 \le 5.5V$ (Note 7)	ParameterConditions(V)Quiescent Supply Current $V_I = V_{CC} \text{ or GND}$ $2.3 - 3.6$ $3.6V \le V_I, V_O \le 5.5V$ (Note 7) $2.3 - 3.6$	ParameterConditions(V)Quiescent Supply Current $V_1 = V_{CC}$ or GND $2.3 - 3.6$ $3.6V \le V_1$, $V_0 \le 5.5V$ (Note 7) $2.3 - 3.6$	Parameter Conditions (V) Min Max Quiescent Supply Current V _I = V _{CC} or GND 2.3 - 3.6 20 3.6V ≤ V _I , V _O ≤ 5.5V (Note 7) 2.3 - 3.6 ±20

74LCX16374

Note 7: Outputs disabled or 3-STATE only.

AC Electrical Characteristics

			T _A =	-40° to +8	85°C, R _L =	500 Ω		
Symbol	Demonster	$V_{CC} = 3.3V \pm 0.3V$ $V_{CC} = 2.7V$		V _{CC} = 2.	$V_{CC}=\textbf{2.5V}\pm\textbf{0.2V}$			
	Parameter	C _L =	C _L = 50 pF		C _L = 50 pF		30 pF	Units
		Min	Max	Min	Max	Min	Max	
f _{MAX}	Maximum Clock Frequency	170						MHz
t _{PHL}	Propagation Delay	1.5	6.2	1.5	6.5	1.5	7.4	ns
t _{PLH}	CP to O _n	1.5	6.2	1.5	6.5	1.5	7.4	
t _{PZL}	Output Enable time	1.5	6.1	1.5	6.3	1.5	7.9	20
t _{PZH}		1.5	6.1	1.5	6.3	1.5	7.9	ns
t _{PLZ}	Output Disable Time	1.5	6.0	1.5	6.2	1.5	7.2	ns
t _{PHZ}		1.5	6.0	1.5	6.2	1.5	7.2	115
t _S	Setup Time	2.5		2.5		3.0		ns
t _H	Hold Time	1.5		1.5		2.0		ns
t _W	Pulse Width	3.0		3.0		3.5		ns
t _{OSHL}	Output to Output Skew (Note 8)		1.0		1			20
t _{OSLH}			1.0					ns

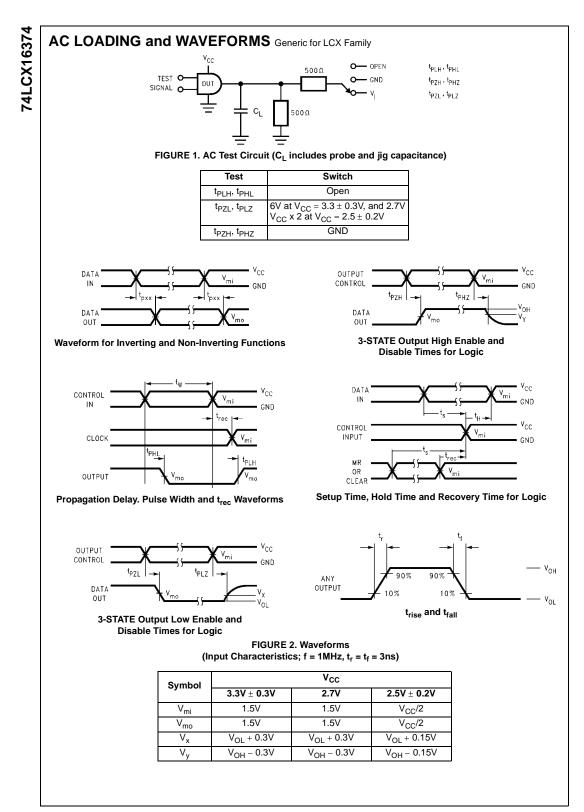
Note 8: Skew is defined as the absolute value of the differences between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}). Parameter guaranteed by design.

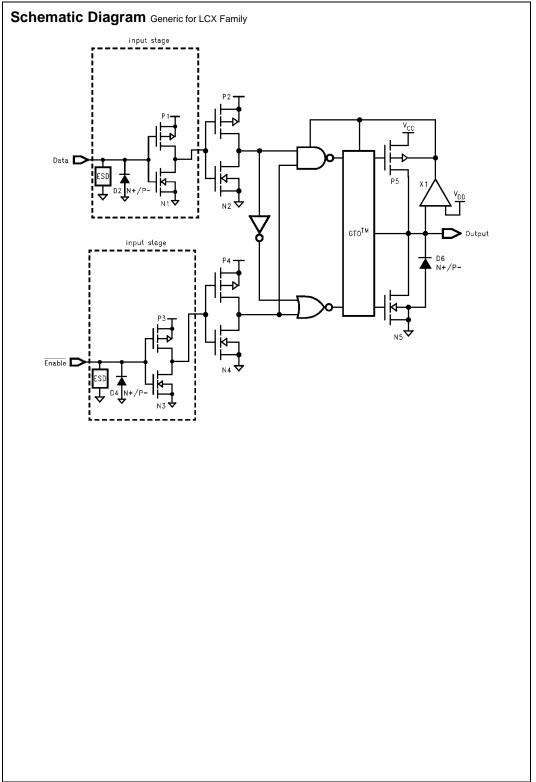
Dynamic Switching Characteristics

Symbol	Parameter	Conditions			
			(V)	Typical	
V _{OLP}	Quiet Output Dynamic Peak V _{OL}	$C_L = 50 \text{ pF}, \text{ V}_{IH} = 3.3 \text{ V}, \text{ V}_{IL} = 0 \text{ V}$	3.3	0.8	V
		$C_L = 30 \text{ pF}, \text{ V}_{IH} = 2.5 \text{V}, \text{ V}_{IL} = 0 \text{V}$	2.5	0.6	v
V _{OLV}	Quiet Output Dynamic Valley V _{OL}	$C_L = 50 \text{ pF}, V_{IH} = 3.3 \text{V}, V_{IL} = 0 \text{V}$	3.3	-0.8	V
		$C_L = 30 \text{ pF}, \text{ V}_{IH} = 2.5 \text{V}, \text{ V}_{IL} = 0 \text{V}$	2.5	0.6	V

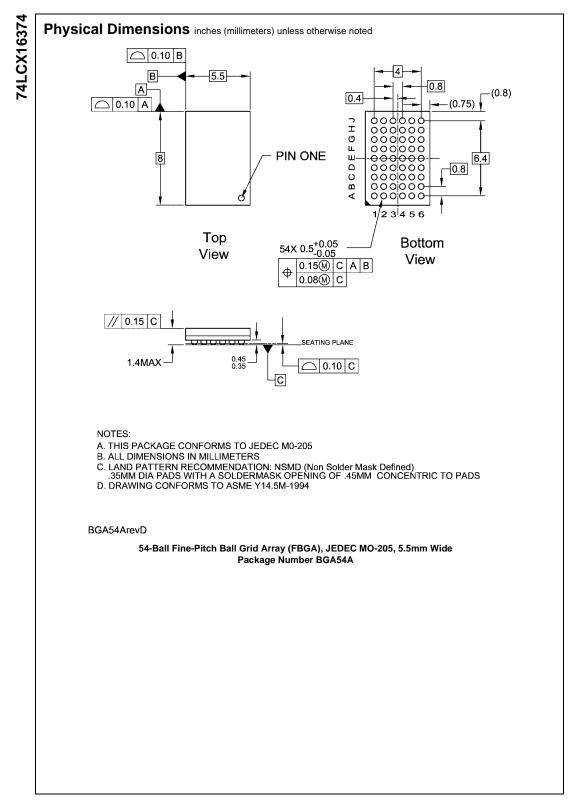
Capacitance

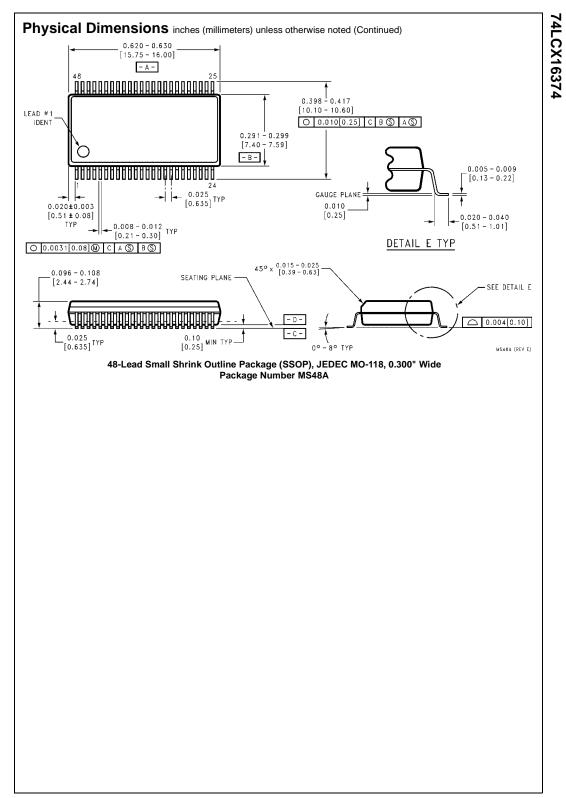
Symbol	Parameter	Conditions	Typical	Units
CIN	Input Capacitance	$V_{CC} = Open, V_I = 0V \text{ or } V_{CC}$	7	pF
C _{OUT}	Output Capacitance	$V_{CC} = 3.3V$, $V_I = 0V$ or V_{CC}	8	pF
C _{PD}	Power Dissipation Capacitance	$V_{CC} = 3.3V$, $V_I = 0V$ or V_{CC} , f = 10 MHz	20	pF

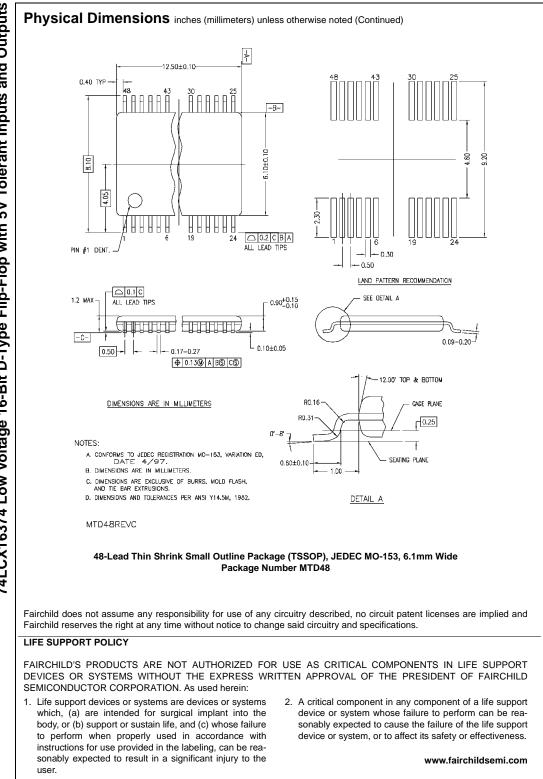




74LCX16374







74LCX16374 Low Voltage 16-Bit D-Type Flip-Flop with 5V Tolerant Inputs and Outputs

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC